



Single-photon spectroscopy of SiN_x using an integrated superconducting single-photon detector*

M. A. Dryazgov,¹ N. A. Vovk,¹ M. V. Shibalov,¹ A. M. Mumlyakov,¹ N. Yu. Dmitriev,^{1,2} I. A. Filippov,¹
I. V. Trofimov,¹ Yu. P. Korneeva,¹ A. A. Korneev,^{1,3} M. A. Tarkhov¹

¹ Institute of Nanotechnology of Microelectronics of Russian Academy of Science, Moscow, Russia

² Russian Quantum Center, Moscow, Russia

³ National Research University Higher School of Economics (HSE University), Moscow, Russia

submitted 07 August 2026, accepted 21 August 2026, published 29 August 2026

The work describes the use of a superconducting NbN detector for spectroscopy of an optical SiN_x waveguide at cryogenic temperatures at strongly attenuated optical radiation in the single-photon detection regime of the incident radiation in the S-, C-, and L-bands. The technological process of creating the superconducting detector on the planarized surface of a protective SiO_2 layer over the SiN_x optical waveguide is described. The measured photon-count spectrum exhibits a pronounced maximum in the 1540–1555 nm range, consistent with the low-loss spectral region of SiN_x waveguides.

Introduction

The most common platform for implementing compact optical circuits is based on Si_3N_4 optical waveguides surrounded by SiO_2 .¹ Optical spectroscopy in the L- and C-band wavelengths makes it possible to determine the characteristics of fabricated waveguides and the limits of their applicability.² One of the obstacles to performing single-photon spectroscopy of an optical waveguide is the optical fiber-photonic chip interface, which accounts for the greatest optical losses.³ This work describes the technological process for fabricating SiN_x waveguides surrounded by SiO_2 with integrated NbN superconducting single-photon detectors (SSPD) and with fabricated grooves (seating positions) for aligning the centers of the waveguide and the optical fiber. The superconducting detector was used for single-photon spectroscopy of the optical waveguide in the wavelength range from 1480 nm to 1640 nm at a temperature of 2.7 K.

Single-photon spectroscopy

Optical waveguides were formed on a silicon Si substrate with a 4 μm -thick thermally grown silicon dioxide SiO_2 buffer layer. A 400-nm-thick SiN_x layer was deposited by inductively coupled plasma chemical vapor deposition (ICP-CVD) and patterned into waveguides with a width of 1.6 μm using optical lithography. A scanning electron microscope (SEM) image of the fabricated waveguides is shown in blue in figure 1a. The waveguides were subsequently coated with a SiO_2 cladding layer deposited by plasma-enhanced chemical vapor deposition (PECVD),

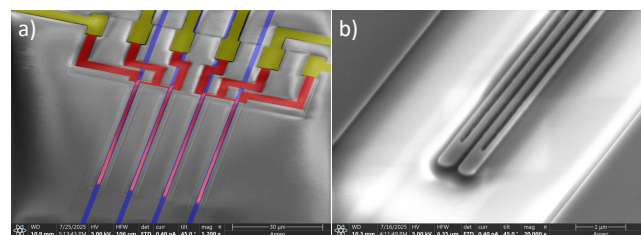


Figure 1. a – (SEM) image of the fabricated chip with indicated optical waveguides (blue), detectors (red), and contacts (yellow); b – SEM images of the magnified section of the integrated detector.

which was then planarized to a thickness of 140 nm above the waveguide surface.⁵

The superconducting detectors were fabricated from a 9-nm-thick NbN film deposited by reactive magnetron sputtering, with the meander structure defined by electron-beam lithography. The superconducting strips have a width of 120 nm and a total length of 600 μm , arranged in a W-shaped configuration, as shown in red in figures 1a and 1b. Contact pads were formed by a lift-off process using 200-nm-thick aluminum, also indicated in yellow in figure 1a. As the final fabrication step, 62.5- μm -deep grooves were etched by the Bosch process to enable edge-coupling of light into the waveguides.

The fabricated chip, with optical fibers attached, was mounted in a closed-cycle cryostat and cooled to 2.7 K. Optical characterization was performed according to the setup shown in figure 2a, with the chip placed in a custom-designed holder, as illustrated in figure 2c.

The waveguide-integrated detector was biased with a direct current to a value of 0.9 of the critical current, which corresponds to a Dark Count Rate (DCR) $\simeq$ 100 Hz. The optical count rate (CPR) was on the order of 10^6 Hz, at which the system detection efficiency was approximately 2% at a wavelength of 1550 nm.

The polarization sensitivity of the fabricated SSPD was evaluated. Figure 2b presents the measured dependence of the photon-count ratio for vertical and horizontal polarizations. We define horizontal polarization as coinciding with the plane of the optical waveguide width of 1.6 μm , and vertical polarization as coinciding with the plane of the optical waveguide height of 0.4 μm . The results clearly demonstrate that the polarization sensitivity

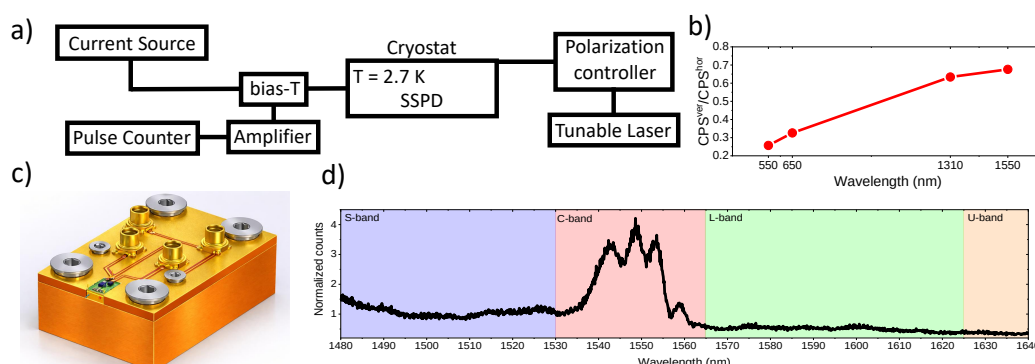


Figure 2. **a** – Schematic of the measurement setup for the optical characterization of the waveguide-integrated detector. **b** – Measured wavelength dependence of the photon-count ratio for orthogonal polarizations. **c** – Photograph of the optical chip holder. **d** – Dependence of the normalized optical count rate on the wavelength.

decreases with increasing wavelength. This is attributed to the waveguide cross-section, in which the width is much greater than the height.

The laser wavelength was continuously swept from 1480 nm to 1640 nm at a rate of $1 \text{ nm} \cdot \text{s}^{-1}$ to obtain the detector count rate as a function of wavelength averaged over 10 measurements, as shown in figure 2d. The obtained dependence is normalized to the average optical count rate to demonstrate a significant change in the optical count rate with wavelength. The relative standard deviation for each measured wavelength value did not exceed 5% over 10 performed measurements. The polarization of the radiation was maintained vertical throughout the measurement using a polarization controller.

The wavelength dependence of the photon counts presented in figure 2d exhibits distinct peaks at wavelengths of 1543 nm, 1549 nm, and 1553 nm. We compare our result with those reported by other research groups and find a good agreement in the overall lineshape of the obtained dependence.^{6,7} We attribute the shape of the dependence of the optical counts on the radiation wavelength to N–H absorption overtones, following the authors of the work who studied the spectral properties of the SiN_x film.⁸ For more accurate conclusions, additional measurements of spectral characteristics are required, for example, using ring resonators.

Conclusion

This work reports on a superconducting NbN detector employed for single-photon spectroscopy of a SiN_x optical waveguide, with the detector integrated onto the waveguide. The averaged photon-count rate as a function of wavelength was measured in the 1480–1640 nm range. We observe an increase in the photon count rate in the region of 1550 nm, which is consistent with observations from other independent groups performed at room temperature and at non-single-photon optical probing powers. It is suggested that the present results may be relevant for practical applications of SiN_x optical waveguides under cryogenic conditions.

Acknowledgements

The study was supported by project No. 125020501540-9 of the Ministry of Education and Science of the Russian Federation. Fabrication and technology characterization were carried out at large scale facility complex for heterogeneous integration technologies and silicon+carbon nanotechnologies.

Contact information

Corresponding author: Mihail Dryazgov,
 orcid.org/0000-0002-6280-4667,
 e-mail dryazgovm@gmail.com

* Proceedings of the II International Scientific Conference "Advanced functional materials for digital and quantum electronics' 26", September 14-18, 2026, Dolgoprudny, Russia

References

- [1] Elshaari A. W., Pernice W., Srinivasan K., Benson O., Zwiller V. *Hybrid integrated quantum photonic circuits*. *Nat. Photon.*, vol. 14, 285–298 (2020).
- [2] Naraine C., Hashemi B., Taleghani N. M., Westwood-Bachman J. N., Horvath C., Frare B., Segat L., Mbonde H. M., Ahmadi P. T., Setzer K., McKinlay A., Kiani K. M., Wang R., Selvaganapathy P. R., Mascher P., Knights A. P., Schmid J. H., Cheben P., Aktary M., Bradley J. D. B. *A Moderate Confinement O-, S-, C-, and L-Band Silicon Nitride Platform Enabled by a Rapid Prototyping Integrated Photonics Foundry Process*. *IEEE Photon. Journ.*, vol. 16, num 6, 1–15 (2024).
- [3] Marchetti R., Lacava C., Carroll L., Gradkowski K., Minzioni P. *Coupling strategies for silicon photonics integrated chips [invited]*. *Photon. Res.*, vol. 7, 201 (2019).
- [4] Mumlyakov A. M., Dmitriev N. Yu., Shibalov M. V., Filippov I. A., Trofimov I. V., Danilin A. N., Lobanov V. E., Bilenko I. A., Tarkhov M. A. *Void-free upper cladding deposition process for low-loss integrated silicon nitride photonics*. *Phys. Rev. Applied*, vol. 22, 054027 (2024).

- [5] Dmitriev N. Yu., Mumlyakov A. M., Shibalov M. V., Filippov I. A., Molodtsova G. V., Trofimov I. V., Brukvina D. A., Bilenko I. A., Tarkhov M. A. *High-performance robust $\text{ScN}_x/\text{Nb}/\text{ScN}_x$ heaters for an integrated silicon nitride low-loss photonic platform*. *Phys. Rev. Applied*, vol. 24, num. 5, 054077 (2025).
- [6] Kempf E., Calvo M., Domengie F., Monfray S., Boeuf F., Charette P. G., Orobitchouk R. *SiN films for integrated photonics deposited by PVD at low temperature*. *Opt. Mater. Express*, vol. 13, 1353 (2023).
- [7] Mao S. C., Tao S. H., Xu Y. L., Sun X. W., Yu M. B., Lo G. Q., Kwong D. L. *Low propagation loss SiN optical waveguide prepared by optimal low-hydrogen module*. *Opt. Express*, vol. 16, 20809 (2008).
- [8] Kou R., Yamamoto N., Fujii G., Aihara T., Tsuchizawa T., Ishizawa A., Hitachi K., Gotoh H., Ukibe M., Yamada K. *Spectrometric analysis of silicon nitride films deposited by low-temperature liquid-source CVD*. *J. Appl. Phys.*, vol. 126, 133101 (2019).